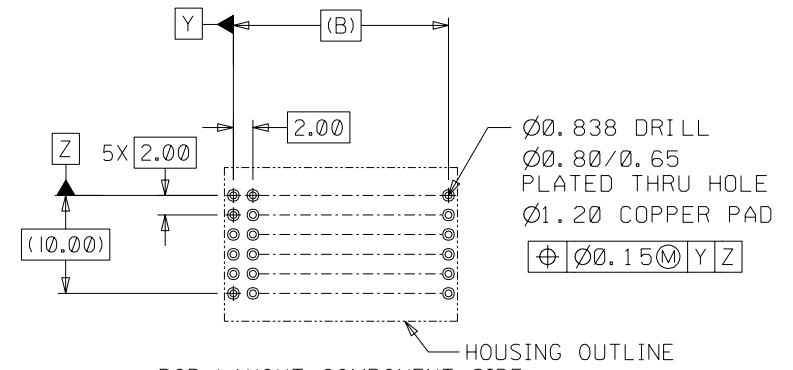
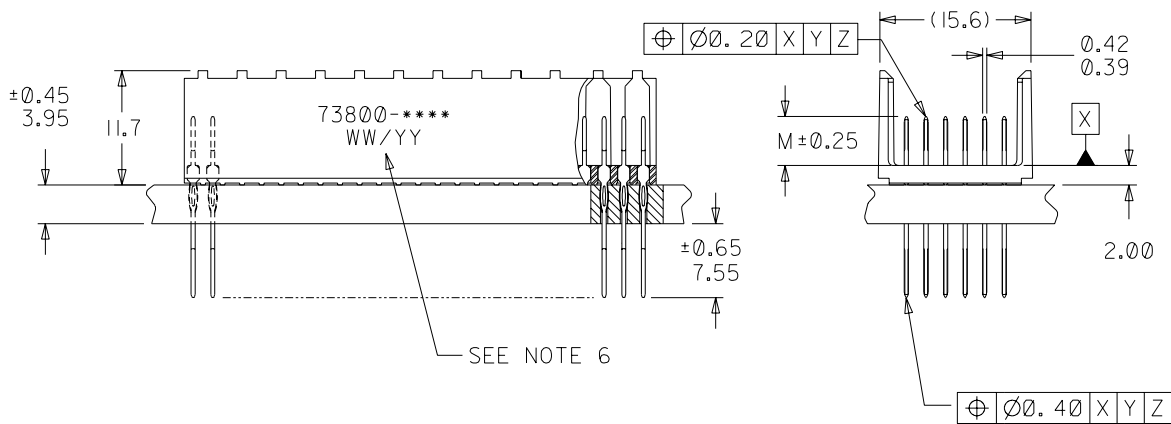
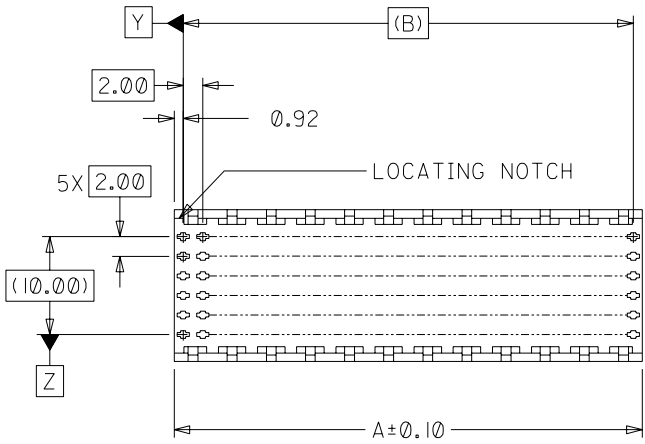


NOTES:

1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL94V-0, COLOR: BLACK, TERMINAL - PHOSPHOR BRONZE.
2. FINISHES: SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MINIMUM THICKNESS; NICKEL (Ni) AND GOLD FLASH OVERALL SELECTIVE GOLD (Au) IN CONTACT AREA, 0.00076mm MINIMUM THICKNESS; SELECTIVE TIN/LEAD (Sn/Pb) IN COMPLIANT AREA, NICKEL (Ni) OVERALL.
3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-73780-999.
4. FOR MIXED CONTACT MATING LENGTHS, CONSULT FACTORY FOR AVAILABILITY.
5. PACKAGE PER PK-70873-0868.
6. PARTS MARKED WITH PART NUMBER AND DATE CODE, ON EITHER SIDE, APPROXIMATELY WHERE SHOWN.



PCB LAYOUT: COMPONENT SIDE
RECOMMENDED PCB THICKNESS: 3.95±0.45

MATERIAL NUMBER	NUMBER OF CONTACTS	DIM "A"	DIM "B"	DIM "M"	PLATING
73800-0000	72	23.84	22.00	5.00	GOLD/GOLD FLASH
73800-0200	72	23.84	22.00	6.00	GOLD/GOLD FLASH
73800-1000	144	47.84	46.00	5.00	GOLD/GOLD FLASH
73800-1200	144	47.84	46.00	6.00	GOLD/GOLD FLASH
73800-2000	72	23.84	22.00	5.00	GOLD/TIN-LEAD
73800-2200	72	23.84	22.00	6.00	GOLD/TIN-LEAD
73800-3000	144	47.84	46.00	5.00	GOLD/TIN-LEAD
73800-3200	144	47.84	46.00	6.00	GOLD/TIN-LEAD

REVISED
EC NO. UCP2004-1438
DRWN: BINGHAM 04/02/04
CHK: REED 04/02/04
APPR: BIXLER 04/02/04

QUALITY SYMBOLS
MAJOR $\nabla = 0$
CRITICAL $\nabla C = 0$

DESCRIPTION
REV H

GENERAL TOLERANCES: (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	±0.	±.
3 PLACES	±0.	±.
2 PLACES	±0.05	±.
1 PLACE	±0.10	±.

ANGULAR: ± 1/2°

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

SCALE 2 : 1

DESIGN UNITS mm INCH

THIRD ANGLE PROJECTION

DRAWN BY & DATE
JBINGHAM 97/05/16

CHECKED BY & DATE
SREED 97/05/16

APPROVED BY & DATE
CBIXLER 97/05/16

CAD FILENAME
S73800X1.DGN

TITLE: SALES ASSEMBLY
HDM DOUBLE-END MIDPLANE
OPEN END OPTION

MOLEX MOLEX INCORPORATED

MATERIAL NO. SEE CHART
DRAWING NO. SD-73800-001
SHEET NO. 1 OF 1

SIZE B